

Amendments to the Specification:

Please replace paragraphs [0020], [0021], [0022], [0023], [0030], [0031], [0032], [0033], [0034], [0035], [0036], [0038], [0040], [0041], [0044], [0045], [0046], [0047], [0049], [0052], [0053], [0054], [0056], [0059], and [0060] with the following amended paragraphs:

[0020] The temperature management system manages the temperature of one or more thermal components in downhole tools, such as those suspended on a drill string or a wireline. The temperature management system comprises a heat exchanger thermally coupled with the thermal component, or thermally coupled with a chassis of thermal components. The temperature management system also comprises a ~~heat sink~~heat storage unit. A thermal conduit system thermally couples the heat exchanger and ~~heat sink~~the heat storage unit. The thermal conduit system transfers heat absorbed by the heat exchanger from the one or more thermal components to the ~~heat sink~~heat storage unit. The ~~heat sink~~heat storage unit may in turn absorb the heat from the thermal conduit or directly from the one or more thermal components. A second, different heat exchanger coupled to the ~~heat sink~~heat storage unit may be utilized to efficiently transfer heat from the thermal conduit. The ~~heat sink~~heat storage unit may be disposed locally to the thermal component, or may be remotely disposed, e.g., the ~~heat sink~~heat storage unit may be in the same cavity as the one or more thermal components, or may be located external to the thermal component cavity. The temperature management system is thus able to discretely manage the temperature of thermal components inside a cavity instead of managing the temperature of the cavity as a whole.

[0021] In another embodiment of the invention, the thermal conduit system comprises a closed loop, coolant fluid conduit system. A fluid transfer device circulates coolant fluid through the conduit system. As the coolant fluid circulates through the thermal conduit system, the coolant flows through the heat exchanger, absorbing heat from the heat exchanger and enabling the heat exchanger to absorb more heat from the thermal component. After exiting the heat exchanger coupled to the thermal component(s), the heated coolant fluid flows to the ~~heat sink~~heat storage unit wherein the ~~heat sink~~heat storage unit absorbs heat from the coolant, thus enabling the coolant to absorb more heat from the one or more thermal components. After exiting the ~~heat sink~~heat storage unit, the coolant fluid may circulate through the temperature management system.

[0022] In one embodiment of the invention, the temperature management system may comprise an open loop, coolant fluid conduit system. Instead of re-circulating coolant fluid through the fluid conduit system, the temperature management system may store or even expel the coolant fluid after the coolant fluid flows through the heat exchanger and the ~~heat sink~~heat storage unit.

[0023] In another embodiment of the invention, for multiple thermal components, each thermal component or group of components may require a separate heat exchanger. To accommodate the multiple heat exchangers, the thermal conduit system comprises thermal conduit branches that branch out to each heat exchanger and then rejoin or recombine for flow of the coolant fluid to the ~~heat sink~~heat storage unit. The multiple heat exchangers may be arranged in series, in parallel, or any combination of series and/or parallel. Alternatively, the temperature management system may further comprise valves for controlling fluid flow through each thermal conduit branch if the conduit system is a coolant fluid conduit system. The valves can control the flow through the thermal conduit branches to isolate particular heat exchangers from the temperature management system when the cooling of that component or group of components is not necessary.

[0030] The temperature management system 10 also comprises a ~~heat sink~~heat storage unit 22 preferably comprising a phase change material. Phase change material is designed to take advantage of the heat absorbed during the phase change at certain temperature ranges. For example, the phase change material may be a eutectic material. Eutectic material is an alloy having a component composition designed to achieve a desired melting point for the material. The desired melting point takes advantage of latent heat of fusion to absorb energy. Latent heat is the energy absorbed by the material as it changes phase from solid into liquid. Thus, when the material changes its physical state, it absorbs energy without a change in the temperature of the material. Therefore, additional heat will only change the phase of the material, not its temperature. To take advantage of the latent heat of fusion, the eutectic material may have a melting point below the desired maintenance temperature of the thermal component 12.

[0031] The ~~heat sink~~heat storage unit 22 is stored in a jacket 24 capable of withstanding the extreme downhole temperatures and shock conditions. For example, the jacket 24 can be a stainless steel container. Because the ~~heat sink~~heat storage unit 22 may undergo a phase change, the jacket 24 must also be capable of withstanding the contraction and/or expansion of the ~~heat sink~~heat storage unit 22.

[0032] The heat exchanger 20 and ~~heat sink~~ the heat storage unit 22 are thermally coupled via a thermal conduit system 26. The thermal conduit system 26 comprises a thermally conductive material for transferring heat from the heat exchanger 20 to the ~~heat sink~~ heat storage unit 22. The thermal conduit system 26 may connect to the heat exchanger 20 and the ~~heat sink~~ heat storage unit 22 by any suitable means such as welding joints or threaded connections.

[0033] The temperature gradient between thermal component 12 and the ~~heat sink~~ heat storage unit 22 is such that the ~~heat sink~~ heat storage unit 22 absorbs the heat from the thermal component 12 through the heat exchanger 20 and the thermal conduit system 26. The temperature management system 10 removes enough heat to maintain the thermal component 12 at or below its rated temperature, which may be *e.g.* 125°C. In one embodiment of the invention, the temperature management system 10 may maintain the component 12 at or below 100°C, or even at or below 80°C. Typically, the lower the temperature, the longer the life of the thermal component 12.

[0034] Thus, the temperature management system 10 may not manage the temperature of the entire cavity 15 or even the entire electronics chassis, but does manage the temperature of the thermal component 12 itself. When absorbing heat discretely from the thermal component 12, the temperature management system 10 may allow the temperature of the cavity 15 to reach a higher temperature than that of the thermal components. Absorbing heat discretely from the thermal component 12 thus extends the useful life of the thermal component 12, despite the temperature of the cavity 15 being higher. This allows the thermal component to operate a longer duration at a given temperature for a given volume of ~~heat sink~~ heat storage unit than possible if the temperature of the entire cavity is managed.

[0035] Because the temperature of the downhole environment may be greater than the temperature of the ~~heat sink~~ heat storage unit 22, in one embodiment of the invention, the heat removed from the thermal component 12 and transmitted by the thermal conduit 26 is stored in the ~~heat sink~~ heat storage unit 22. In other embodiments of the invention, the heat removed from the thermal component 12 may be absorbed directly by the ~~heat sink~~ heat storage unit 22; *e.g.*, via conduction by being in contact with the heat exchanger, or the heat may be absorbed by the ~~heat sink~~ heat storage unit 22 via convection or radiation from the heat exchanger. Consequently, the amount of heat the ~~heat sink~~ heat storage unit 22 can absorb from the thermal component 12 limits the temperature management system 10. When the ~~heat sink~~ heat storage unit 22 reaches its heat

storage capacity, the downhole tool 14 is brought up closer to the surface or removed from the well 13 and the heat stored in the ~~heat sink~~heat storage unit 22 dissipates into the cooler environment.

[0036] FIGURES 2 and 3 show an alternative temperature management system 210. The temperature management system 210 also discretely cools a thermal component 212 using a heat exchanger 220 to absorb heat from the thermal component 212. The heat exchanger 220 transfers the absorbed heat through a thermal conduit system 226 to a ~~heat sink~~heat storage unit 222. The ~~heat sink~~heat storage unit 222 also comprises a phase change material and is enclosed in a jacket 224.

[0038] The temperature management system 210 also differs from the temperature management system 10 shown in FIGURE 1 in that the thermal conduit system 226 is a coolant fluid conduit system. The thermal conduit system 226 allows the passage of coolant fluid from the heat exchanger 220 to the ~~heat sink~~heat storage unit 222. The thermal conduit system 226 also allows the coolant fluid to return to the heat exchanger 220 to form a closed-loop system.

[0040] The coolant fluid flowing within the thermal conduit system 226 is a coolant fluid that may be thermally coupled with the heat exchanger 220 and the ~~heat sink~~heat storage unit 222. The coolant fluid may be water or any other suitable fluid. The temperature management system 210 may be a single-phase temperature management system. Thus, the coolant is a liquid and does not undergo a phase change while it circulates through the temperature management system 210. Alternatively, the temperature management system 210 may be a two-phase system where the coolant fluid changes to a gas phase and then back to the fluid phase as it cycles through the temperature management system 210. The two-phase system coolant fluid absorbs heat as it changes from the liquid to the gas phase and releases heat as it changes from the gas to the liquid phase.

[0041] In operation, the coolant travels from the fluid transfer device 228 to the heat exchanger 220 where the coolant is thermally coupled with the heat exchanger 220. The coolant passes into the inlet port 220c of the heat exchanger 220 and flows through the stacked plates 220a. As the coolant flows through the heat exchanger 220, it absorbs heat from the heat exchanger 220, thus allowing the heat exchanger 220 to absorb more heat from the thermal component 212. Upon exiting the heat exchanger 220 through outlet port 220d, the heated coolant flows through the thermal conduit system 226 to the ~~heat sink~~heat storage unit 222. The ~~heat sink~~heat storage unit

222 absorbs heat from the coolant, returning the coolant to a lower temperature. The thermal conduit system 226 maintains the coolant fluid separate from the phase change material inside the ~~heat sink~~heat storage unit 222. The path of the thermal conduit system 226 through the ~~heat sink~~heat storage unit 222 may be straight or tortuous depending on the performance specifications of the temperature management system 210. After exiting the ~~heat sink~~heat storage unit 222, the coolant flows to the fluid transfer device 228, where it circulates through the temperature management system 210 again.

[0044] Because the temperature of the downhole environment may be greater than the temperature of the ~~heat sink~~heat storage unit 222, the heat removed from the coolant is stored in the ~~heat sink~~heat storage unit 222. Consequently, the amount of heat the ~~heat sink~~heat storage unit 222 can absorb from the thermal component 212 limits the temperature management system 210. When the ~~heat sink~~heat storage unit 222 reaches its heat storage capacity, the downhole tool 214 is brought up closer to the surface or removed from the well 213 and the heat stored in the ~~heat sink~~heat storage unit 222 dissipates into the cooler environment.

[0045] FIGURE 4 shows an alternative temperature management system 410. The temperature management system 410 also discretely absorbs heat from a thermal component 412 using a heat exchanger 420. The heat exchanger 420 in the temperature management system 410 is also a micro-capillary heat exchanger similar to the heat exchanger 220 shown in FIGURES 3 and 4. The heat exchanger 420 transfers the absorbed heat through a thermal conduit system 426 from a ~~heat sink~~heat storage unit 422. The ~~heat sink~~heat storage unit 422 comprises a phase change material and is enclosed in a jacket 424.

[0046] The temperature management system 410 also uses a fluid thermal conduit system 426. The thermal conduit system 426 allows the passage of the coolant fluid from the ~~heat sink~~heat storage unit 422 to the heat exchanger 420. Unlike the thermal conduit system 226 shown in FIGURE 2 however, the thermal conduit system 426 is an open loop system as shown in FIGURE 4. Thus, the coolant fluid cycles through the temperature management system 410 only once and then is expelled from the temperature management system 410.

[0047] Located in the thermal conduit system 426 is a fluid transfer device 428 for flowing the coolant fluid through the thermal conduit system 426. The fluid transfer device may be located at any suitable location in the temperature management system 410. The fluid transfer device 428

may also be any suitable device for flowing the coolant fluid. By way of non-limiting example, the fluid transfer device may be a pump, such as a mini-pump or a micro-pump. The coolant fluid flowing within the thermal conduit system 426 is thermally coupled with the heat exchanger 420 and the ~~heat sink~~heat storage unit 422. The coolant fluid may be water or any other suitable fluid.

[0049] As shown in FIGURE 4, the coolant fluid travels from the low temperature ~~heat sink~~heat storage unit 422 to the heat exchanger 420 where the coolant is thermally coupled with the heat exchanger 420. The heat exchanger 420 is thermally coupled with the thermal component 412 by conduction, convection, and/or radiation paths. As the coolant flows through the heat exchanger 420, it absorbs heat from the heat exchanger 420, allowing the heat exchanger 420 to absorb more heat from the thermal component 412. Upon exiting the heat exchanger 420, the heated coolant flows through the thermal conduit system 426 and is expelled from the temperature management system 410 as shown by direction arrow 432.

[0052] The amount of cooling fluid and the heat absorption capacity of the ~~heat sink~~heat storage unit 422 limit the amount of heat the temperature management system 410 can absorb from the thermal component 412. When the cooling fluid is depleted, the downhole tool 414 is removed from the well 413 to be supplied with more coolant fluid.

[0053] FIGURE 5 shows an alternative temperature management system 510. The temperature management system 510 may be configured such that the coolant fluid flows through a heat exchanger 520 and then through the thermal conduit system 526 to the ~~heat sink~~heat storage unit 522, similar to the temperature management system 210 shown in FIGURES 2 and 3. As the fluid transfer device 528 flows coolant through the ~~heat sink~~heat storage unit 522, the ~~heat sink~~heat storage unit 522 absorbs heat from the coolant fluid. The thermal conduit system 526 maintains the coolant fluid separate from the phase change material inside the ~~heat sink~~heat storage unit 522. The path of the thermal conduit system 526 through the ~~heat sink~~heat storage unit 522 may be straight or tortuous depending on the performance specifications of the temperature management system 510. Unlike the temperature management system 210 shown in FIGURE 2, the temperature management system 510 is an open loop system similar to temperature management system 410 shown in FIGURE 4. Thus, after exiting the ~~heat sink~~heat storage unit 522, the coolant is expelled from the temperature management system 510.

[0054] Located in the thermal conduit system 526 is a fluid transfer device 528 for flowing the coolant fluid through the thermal conduit system 526. The fluid transfer device may be located at any suitable location in the temperature management system 510. The fluid transfer device 528 may also be any suitable device for flowing the coolant fluid. By way of non-limiting example, the fluid transfer device may be a pump, such as a mini-pump or a micro-pump. The coolant fluid flowing within the thermal conduit system 526 is thermally coupled with the heat exchanger 520 and the ~~heat sink~~heat storage unit 522. The coolant fluid may be water or any other suitable fluid.

[0056] As shown in FIGURE 5, the coolant fluid travels through the heat exchanger 520. The heat exchanger 520 is thermally coupled with the thermal component 512 by conduction, convection, and/or radiation paths. As the coolant flows through the heat exchanger 520, it absorbs heat from the heat exchanger 520, allowing the heat exchanger 520 to absorb more heat from the thermal component 512. Upon exiting the heat exchanger 520, the heated coolant flows through the thermal conduit system 526 and then through the ~~heat sink~~heat storage unit 522. After passing through the ~~heat sink~~heat storage unit 522, the coolant is expelled from the temperature management system 510 as shown by direction arrow 532.

[0059] The amount of cooling fluid and the heat absorption capacity of the ~~heat sink~~heat storage unit 522 limit the amount of heat the temperature management system 510 can absorb from the thermal component 512. When the cooling fluid is depleted, the downhole tool 514 is removed from the well 513 to be supplied with more coolant fluid.

[0060] FIGURE 6 shows another alternative temperature management system 610. The temperature management system 610 can be configured for any of the preceding temperature management systems 10, 210, 410, 510. However, as an example only, the temperature management system 610 will be discussed with reference to the temperature management system 210 shown in FIGURE 2. Unlike the previous temperature management systems, the temperature management system 610 may be used to remove heat from multiple thermal components 612 with multiple heat exchangers 620. A single heat exchanger 620 may also remove heat from a group of thermal components 612. To accommodate the multiple heat exchangers 620, the thermal conduit system 626 additionally comprises thermal conduit branches 631 directing coolant to each heat exchanger 620. FIGURE 6 shows the heat exchangers 620 connected in parallel. However, the heat exchangers 620 may also be in series, or

January 19, 2005

Reply to Office action dated October 20, 2004

any combination of series and/or parallel. After the coolant exits each heat exchanger 620, the thermal conduit branches 631 rejoin to form a single thermal conduit flowing to the ~~heat sink~~-heat storage unit 622. Alternatively, there are valves 630 for controlling fluid flow to each heat exchanger 620. The valves 630 can control flow of the coolant fluid to isolate particular heat exchangers 620 from the thermal conduit system 626 when the cooling of that component or group of components 612 is not necessary.